

Small switching (500V, 2A)

2SK2715

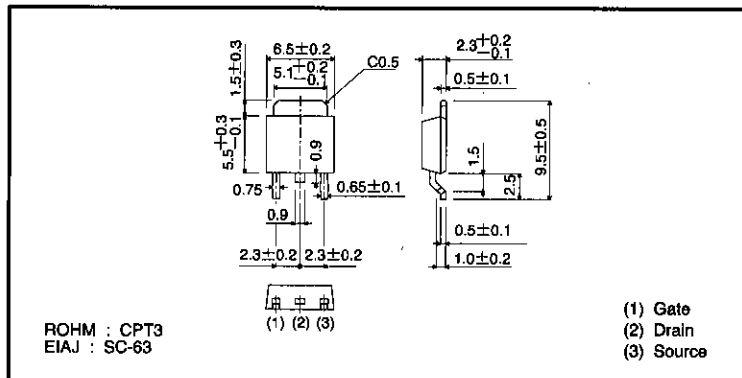
●Features

- 1) Low on-resistance.
- 2) High-speed switching.
- 3) Wide SOA (safe operating area).
- 4) Gate-source voltage guaranteed at $V_{GS} = \pm 30V$.
- 5) Easily designed drive circuits.
- 6) Easy to use in parallel.

●Structure

Silicon N-channel
MOSFET transistor

●External dimensions (Units: mm)



●Absolute maximum ratings ($T_a = 25^\circ C$)

Parameter	Symbol	Limits	Unit	
Drain-source voltage	V_{DS}	500	V	
Gate-source voltage	V_{GS}	± 30	V	
Drain current	Continuous	I_D	2	A
	Pulsed	I_{DP}^*	6	A
Drain reverse current	Continuous	I_{DR}	2	A
	Pulsed	I_{DRP}^*	6	A
Total power dissipation ($T_c=25^\circ C$)	P_D	20	W	
Channel temperature	T_{ch}	150	$^\circ C$	
Storage temperature	T_{stg}	$-55 \sim 150$	$^\circ C$	

* $P_w \leq 10 \mu s$, Duty cycle $\leq 1\%$

●Packaging specifications

Type	Package	Bulk
	Code	TL
	Basic ordering unit (pieces)	2500
2SK2715		○

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●Electrical characteristics (Ta = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate leakage current	I_{GSS}	—	—	± 100	nA	$V_{GS} = \pm 30V, V_{DS} = 0V$
Drain-source breakdown voltage	$V_{(BR)DSS}$	500	—	—	V	$I_D = 1mA, V_{GS} = 0V$
Drain cutoff current	I_{DSS}	—	—	100	μA	$V_{DS} = 500V, V_{GS} = 0V$
Gate threshold voltage	$V_{GS(th)}$	2	—	4	V	$V_{DS} = 10V, I_D = 1mA$
Drain-source on-resistance	$R_{DS(on)}$	—	3	4	Ω	$I_D = 1A, V_{GS} = 10V$
Forward propagation admittance	$ Y_{fs} $	0.6	1.5	—	S	$V_{DS} = 10V, I_D = 1A$
Input capacitance	C_{iss}	—	280	—	pF	$V_{DS} = 10V$
Output capacitance	C_{oss}	—	58	—	pF	$V_{GS} = 0V$
Return capacitance	C_{rss}	—	23	—	pF	$f = 1MHz$
Turn-on delay time	$t_{d(on)}$	—	10	—	ns	$I_D = 1A, V_{DD} = 150V$
Rise time	t_r	—	12	—	ns	$V_{GS} = 10V$
Turn-off delay time	$t_{d(off)}$	—	30	—	ns	$R_L = 150\Omega$
Fall time	t_f	—	63	—	ns	$R_G = 10\Omega$
Reverse recovery time	t_{rr}	—	410	—	ns	$I_{DR} = 2A, V_{GS} = 0V$
Reverse recovery load	Q_{rr}	—	1.7	—	μC	$di/dt = 100A/\mu s$

●Electrical characteristic curves

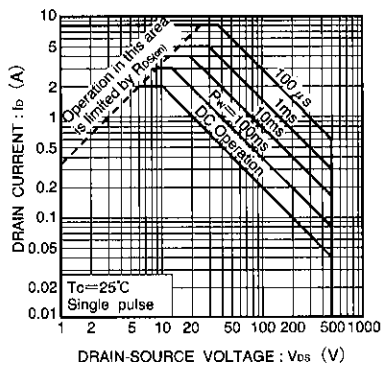


Fig.1 Maximum Safe Operating Area

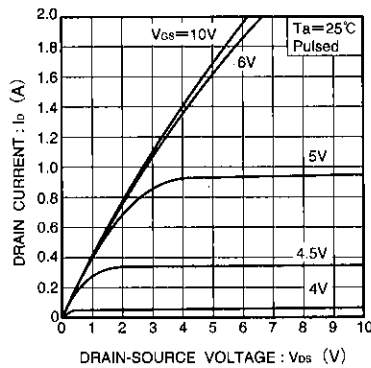


Fig.2 Typical Output Characteristics

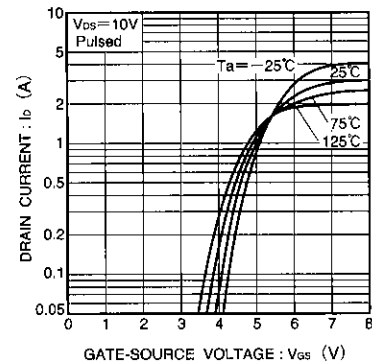


Fig.3 Typical Transfer Characteristics

● Electrical characteristic curves

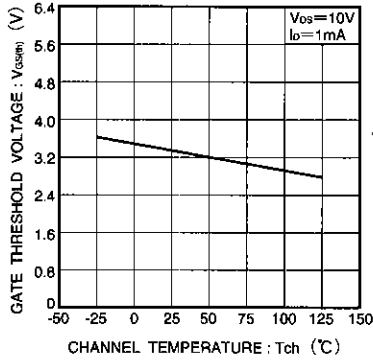


Fig.4 Gate Threshold Voltage vs. Channel Temperature

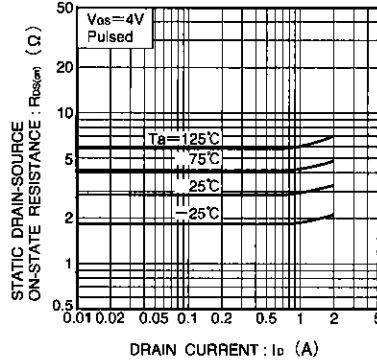


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current

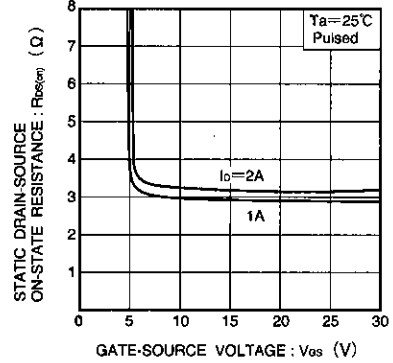


Fig.6 Static Drain-Source On-State Resistance vs. Gate-Source Voltage

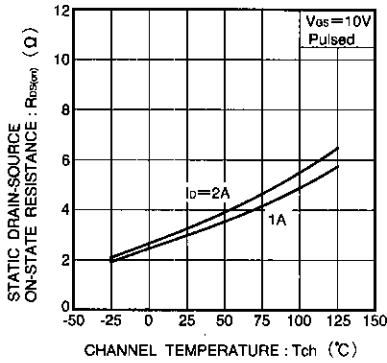


Fig.7 Static Drain-Source On-State Resistance vs. Channel Temperature

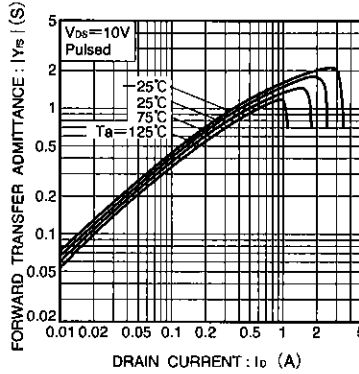


Fig.8 Forward Transfer Admittance vs. Drain Current

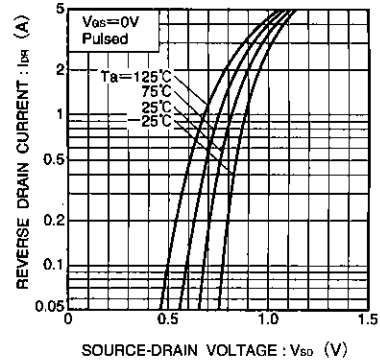


Fig.9 Reverse Drain Current vs. Source-Drain Voltage (I)

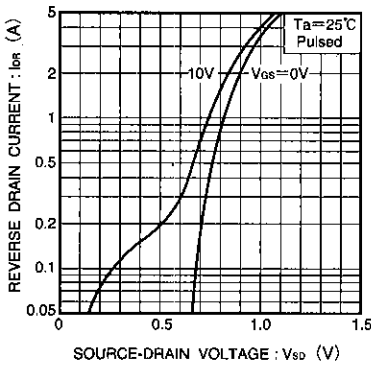


Fig.10 Reverse Drain Current vs. Source-Drain Voltage (II)

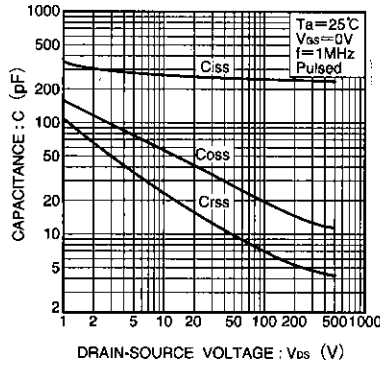


Fig.11 Typical Capacitance vs. Drain-Source Voltage

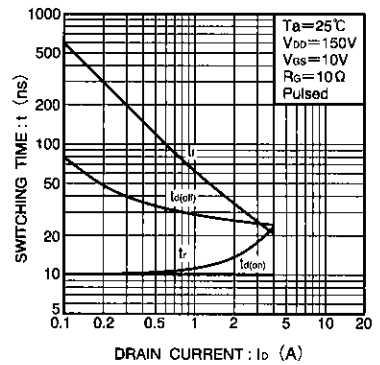


Fig.12 Switching Characteristics (See Figure. 16 and 17 for measurement circuits)



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● Electrical characteristic curves

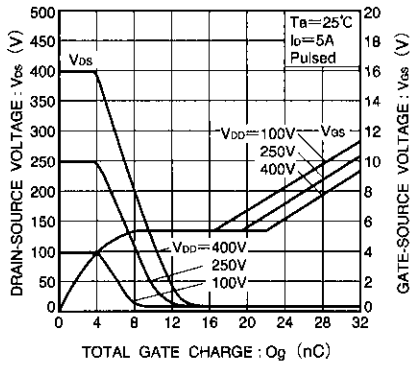


Fig.13 Dynamic Input Characteristics (See Fig. 18 for measurement circuit)

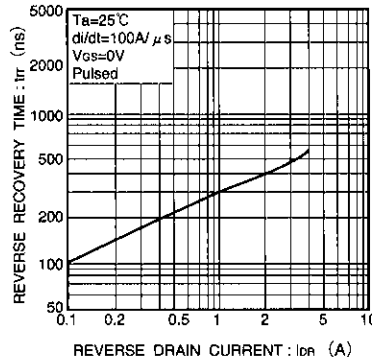


Fig.14 Reverse Recovery Time vs. Reverse Drain Current

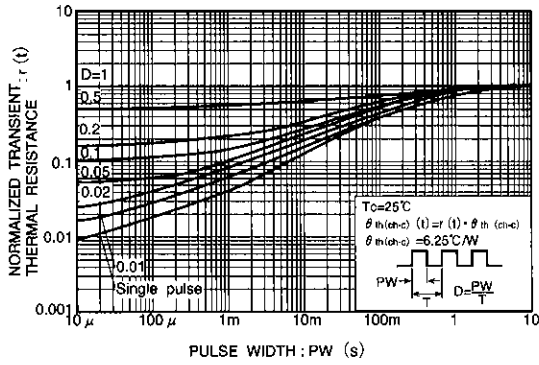


Fig.15 Normalized Transient Thermal Resistance vs. Pulse Width

● Switching characteristics measurement circuit

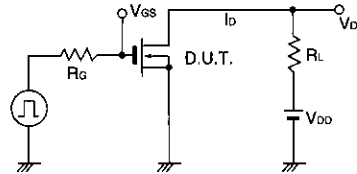


Fig.16 Switching Time Measurement Circuit

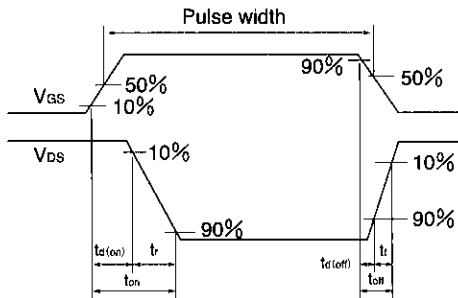


Fig.17 Switching Time Waveforms

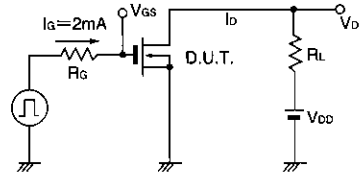


Fig.18 Gate Charge Measurement Circuit

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